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(54) **ELECTRONIC COMPONENT COOLER**

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(71) Applicant: **Danfoss Silicon Power GmbH**,
Flensburg (DE)

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(72) Inventors: **Henning STRÖBEL-MAIER**,
Wanderup (DE); **Karsten LUND**,
Sieverstedt (DE)

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(57) **ABSTRACT**

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A coolant coupling device wherein the cooler includes a cavity wherein the coolant trajectory is altered by an angle of greater than 75 degrees and which is defined by a wall structure incorporating two radii.

